

<IGBT Modules>

# CM600HA-24A

**HIGH POWER SWITCHING USE  
INSULATED TYPE**



single switch

Collector current  $I_C$  ..... **600 A**  
 Collector-emitter voltage  $V_{CES}$  ..... **1200 V**  
 Maximum junction temperature  $T_{jmax}$  ..... **150 °C**

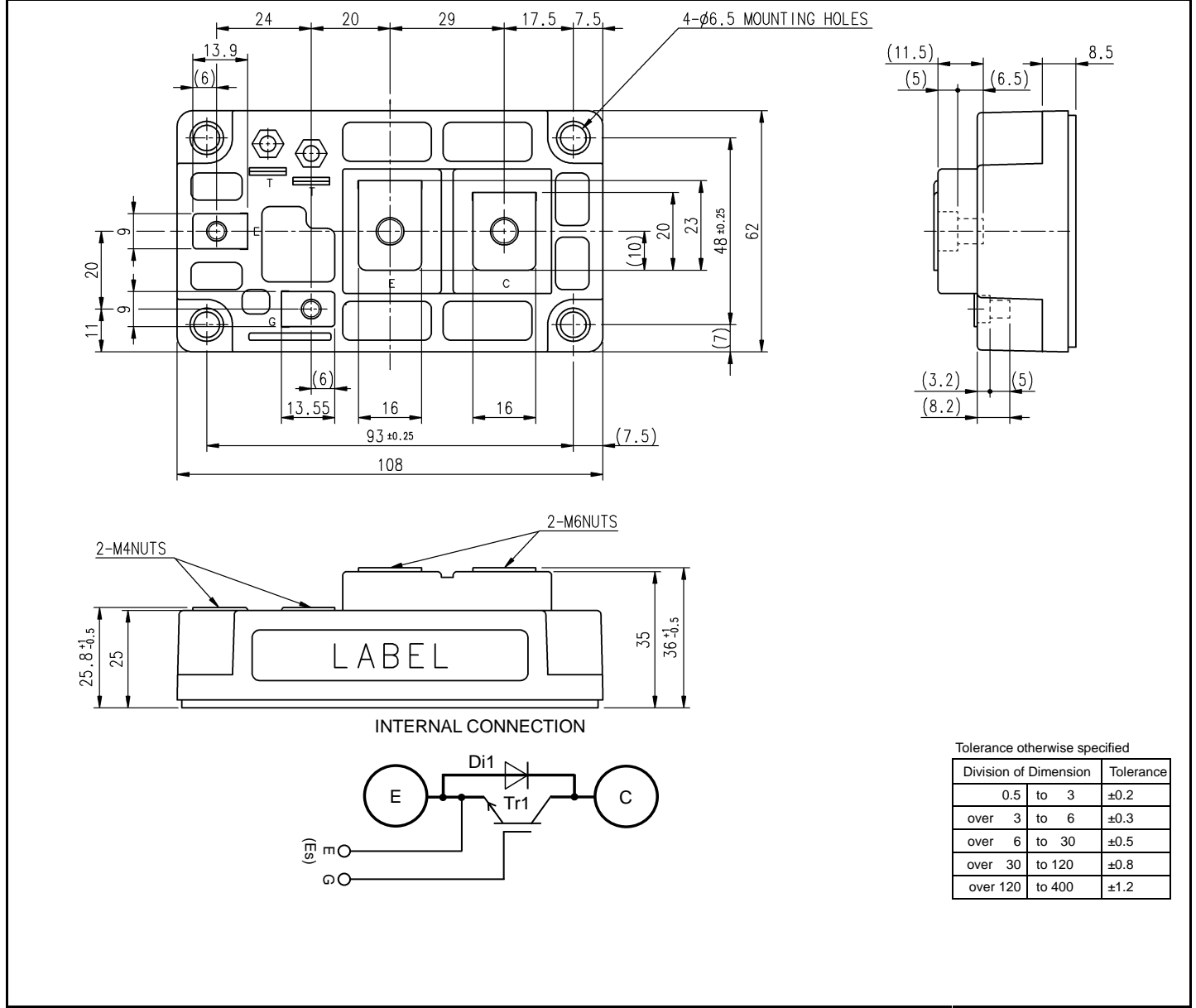
- Flatbase type
- Copper base plate (non-plating)
- Main terminal screws are not attached.
- RoHS Directive compliant
- Recognized under UL1557, File E323585

**APPLICATION**

AC Motor Control, Motion/Servo Control, Power supply, etc.

**OUTLINE DRAWING & INTERNAL CONNECTION**

Dimension in mm



Tolerance otherwise specified

Division of Dimension	Tolerance
0.5 to 3	±0.2
over 3 to 6	±0.3
over 6 to 30	±0.5
over 30 to 120	±0.8
over 120 to 400	±1.2

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## MAXIMUM RATINGS (T<sub>j</sub>=25 °C, unless otherwise specified)

Symbol	Item	Conditions	Rating	Unit
V <sub>CES</sub>	Collector-emitter voltage	G-E short-circuited	1200	V
V <sub>GES</sub>	Gate-emitter voltage	C-E short-circuited	± 20	V
I <sub>C</sub>	Collector current	DC, T <sub>C</sub> =80 °C (Note2, 4)	600	A
I <sub>CRM</sub>		Pulse, Repetitive (Note3)	1200	
P <sub>tot</sub>	Total power dissipation	T <sub>C</sub> =25 °C (Note2, 4)	3670	W
I <sub>E</sub> (Note1)	Emitter current	DC (Note2)	600	A
I <sub>ERM</sub> (Note1)		Pulse, Repetitive (Note3)	1200	
V <sub>isol</sub>	Isolation voltage	Terminals to base plate, RMS, f=60 Hz, AC 1 min	2500	V
T <sub>j</sub>	Operating junction temperature	-	-40 ~ +150	°C
T <sub>stg</sub>	Storage temperature	-	-40 ~ +125	

## ELECTRICAL CHARACTERISTICS (T<sub>j</sub>=25 °C, unless otherwise specified)

Symbol	Item	Conditions	Limits			Unit	
			Min.	Typ.	Max.		
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CE</sub> =V <sub>CES</sub> , G-E short-circuited	-	-	1.0	mA	
I <sub>GES</sub>	Gate-emitter leakage current	V <sub>GE</sub> =V <sub>GES</sub> , C-E short-circuited	-	-	1.0	µA	
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	I <sub>C</sub> =60 mA, V <sub>CE</sub> =10 V	6	7	8	V	
V <sub>CEsat</sub>	Collector-emitter saturation voltage	I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V (Note5) Refer to the figure of test circuit	T <sub>j</sub> =25 °C	-	2.1	3.0	V
			T <sub>j</sub> =125 °C	-	2.4	-	
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> =10 V, G-E short-circuited	-	-	105	nF	
C <sub>oes</sub>	Output capacitance		-	-	9.0		
C <sub>res</sub>	Reverse transfer capacitance		-	-	2.0		
Q <sub>G</sub>	Gate charge	V <sub>CC</sub> =600 V, I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V	-	3.0	-	µC	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>CC</sub> =600 V, I <sub>C</sub> =600 A, V <sub>GE</sub> =±15 V, R <sub>G</sub> =0.52 Ω, Inductive load	-	-	660	ns	
t <sub>r</sub>	Rise time		-	-	190		
t <sub>d(off)</sub>	Turn-off delay time		-	-	700		
t <sub>f</sub>	Fall time		-	-	350		
V <sub>EC</sub> (Note1)	Emitter-collector voltage	I <sub>E</sub> =600 A, G-E short-circuited (Note5) Refer to the figure of test circuit	-	3.0	3.8	V	
t <sub>rr</sub> (Note1)	Reverse recovery time	V <sub>CC</sub> =600 V, I <sub>E</sub> =600 A, V <sub>GE</sub> =±15 V,	-	-	250	ns	
Q <sub>rr</sub> (Note1)	Reverse recovery charge	R <sub>G</sub> =0.52 Ω, Inductive load	-	19	-	µC	
E <sub>on</sub>	Turn-on switching energy per pulse	V <sub>CC</sub> =600 V, I <sub>C</sub> =I <sub>E</sub> =600 A,	-	100	-	mJ	
E <sub>off</sub>	Turn-off switching energy per pulse	V <sub>GE</sub> =±15 V, R <sub>G</sub> =0.52 Ω, T <sub>j</sub> =125 °C,	-	66	-		
E <sub>rr</sub> (Note1)	Reverse recovery energy per pulse	Inductive load	-	29.5	-	mJ	
r <sub>g</sub>	Internal gate resistance	T <sub>C</sub> =25 °C (Note4)	-	1.0	-	Ω	

## THERMAL RESISTANCE CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
R <sub>th(j-c)Q</sub>	Thermal resistance	Junction to case, per IGBT (Note4)	-	-	34	K/kW
R <sub>th(j-c)D</sub>		Junction to case, per FWD (Note4)	-	-	53	
R <sub>th(c-s)</sub>	Contact thermal resistance	Case to heat sink, Thermal grease applied (Note4, 6)	-	20	-	K/kW

## MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
M <sub>t</sub>	Mounting torque	Main terminals M 6 screw	1.96	2.45	2.94	N·m
		G/E auxiliary terminals M 4 screw	0.98	1.18	1.47	
M <sub>s</sub>	Mounting torque	Mounting to heat sink M 6 screw	1.96	2.45	2.94	N·m
m	mass	-	-	480	-	g
e <sub>c</sub>	Flatness of base plate	On the centerline X, Y (Note7)	±0	-	+100	µm

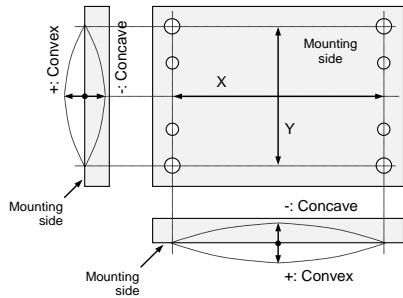
# CM600HA-24A

HIGH POWER SWITCHING USE  
INSULATED TYPE

\*: This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU.

Note1. Represent ratings and characteristics of the anti-parallel, emitter-collector free-wheeling diode (FWD).

- Junction temperature ( $T_{vj}$ ) should not increase beyond  $T_{vjmax}$  rating.
- Pulse width and repetition rate should be such that the device junction temperature ( $T_{vj}$ ) dose not exceed  $T_{vjmax}$  rating.
- Case temperature ( $T_C$ ) and heat sink temperature ( $T_S$ ) are defined on the each surface (mounting side) of base plate and heat sink just under the chips. Refer to the figure of chip location.
- Pulse width and repetition rate should be such as to cause negligible temperature rise. Refer to the figure of test circuit.
- Typical value is measured by using thermally conductive grease of  $\lambda=0.9\text{ W/(m}\cdot\text{K)}$
- The base plate (mounting side) flatness measurement points (X, Y) are as follows of the following figure.

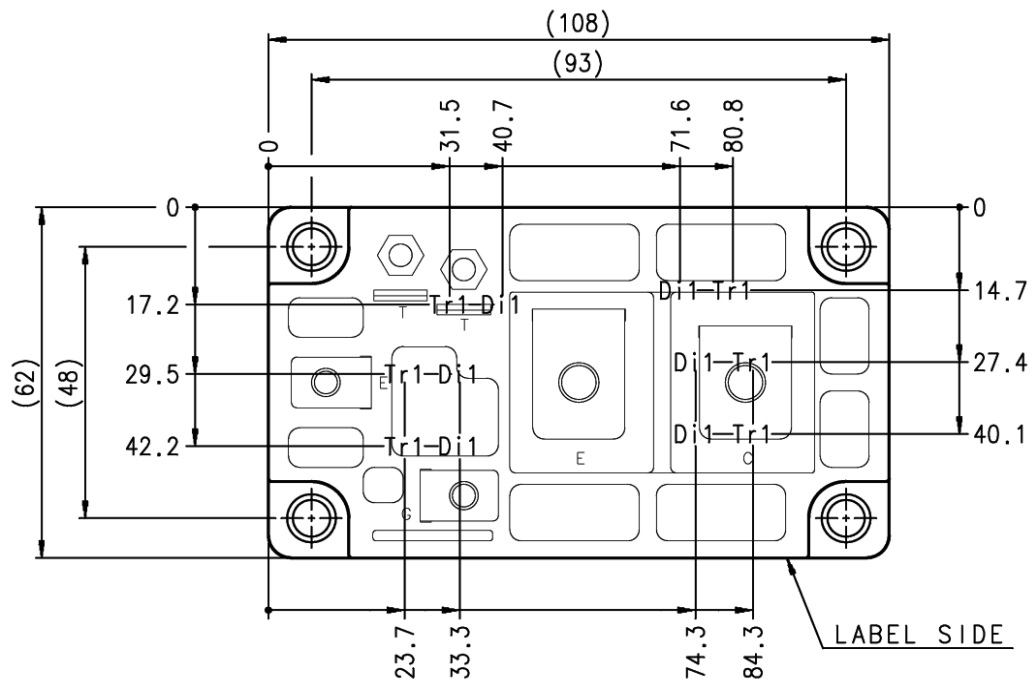


## RECOMMENDED OPERATING CONDITIONS

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
$V_{CC}$	(DC) Supply voltage	Applied across C-E terminals	-	600	800	V
$V_{GEon}$	Gate (-emitter drive) voltage	Applied across G-Es terminals	13.5	15.0	16.5	V
$R_G$	External gate resistance	Per switch	0.52	-	7.8	$\Omega$

## CHIP LOCATION (Top view)

Dimension in mm, tolerance:  $\pm 1\text{ mm}$

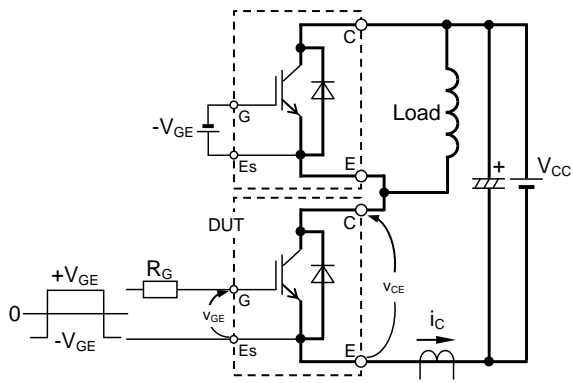


Tr1/Tr2: IGBT, Di1/Di2: FWD

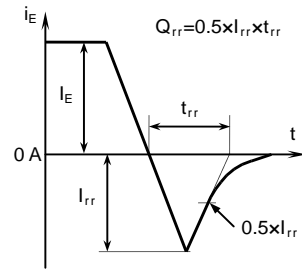
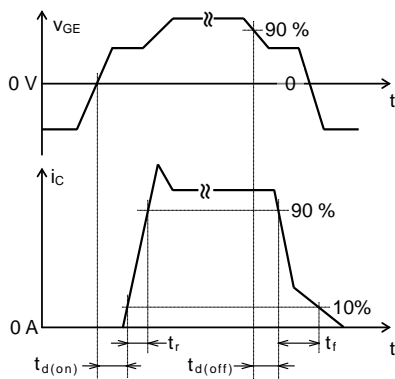
# CM600HA-24A

HIGH POWER SWITCHING USE  
INSULATED TYPE

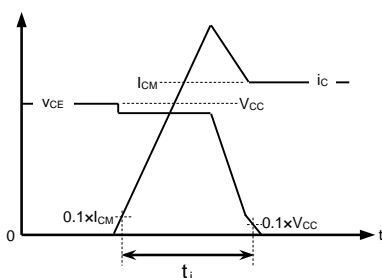
## TEST CIRCUIT AND WAVEFORMS



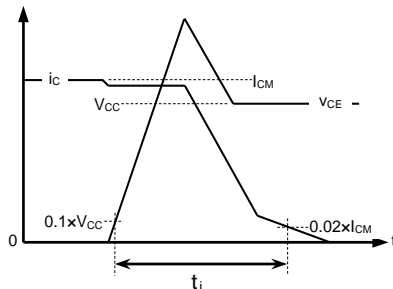
Switching characteristics test circuit and waveforms



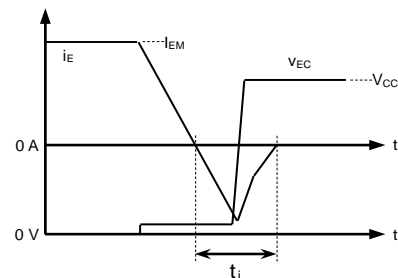
$t_{rr}$ ,  $Q_{rr}$  characteristics test waveform



IGBT Turn-on switching energy



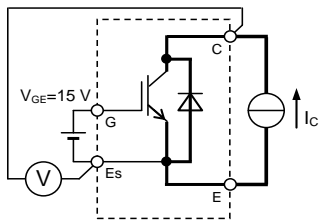
IGBT Turn-off switching energy



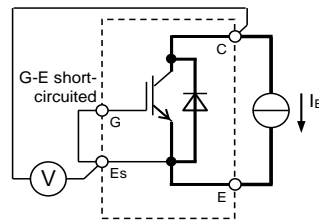
FWD Reverse recovery energy

Turn-on / Turn-off switching energy and Reverse recovery energy test waveforms (Integral time instruction drawing)

## TEST CIRCUIT



$V_{CEsat}$  characteristics test circuit



$V_{EC}$  characteristics test circuit

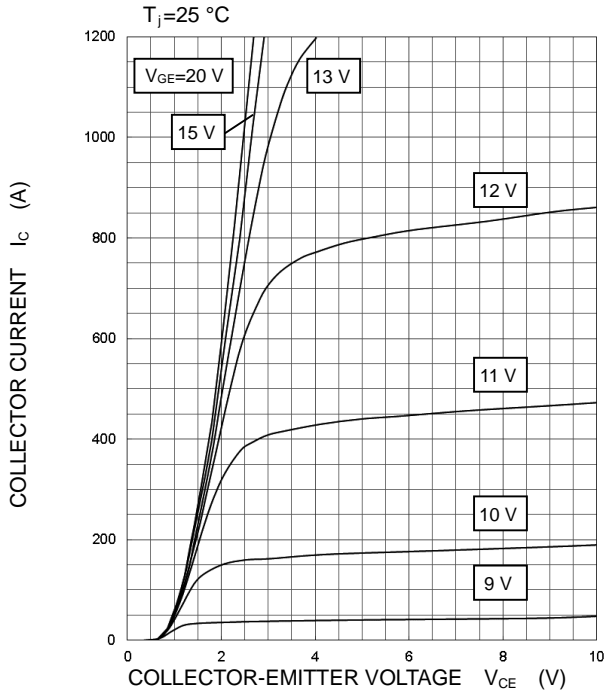
# CM600HA-24A

HIGH POWER SWITCHING USE  
INSULATED TYPE

## PERFORMANCE CURVES

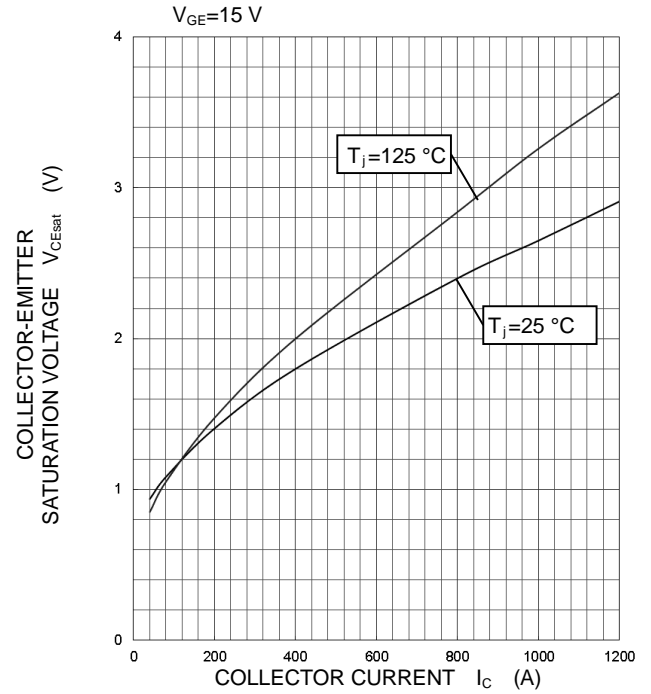
**OUTPUT CHARACTERISTICS**

(TYPICAL)



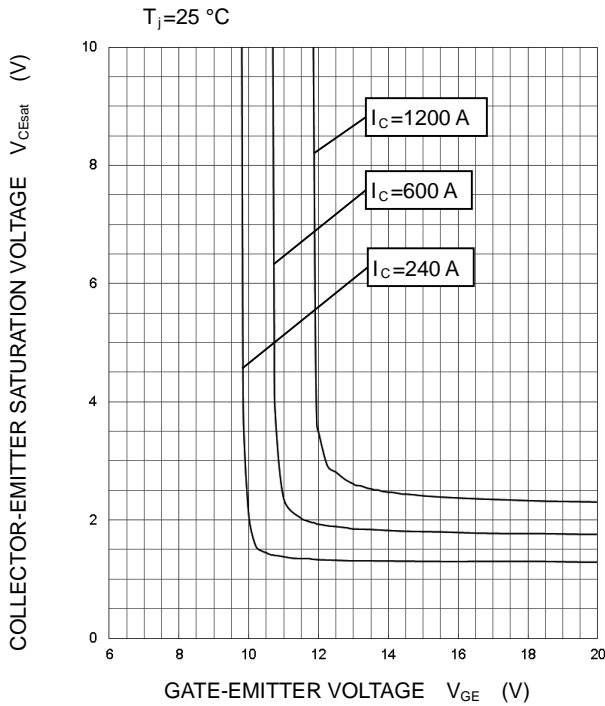
**COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS**

(TYPICAL)



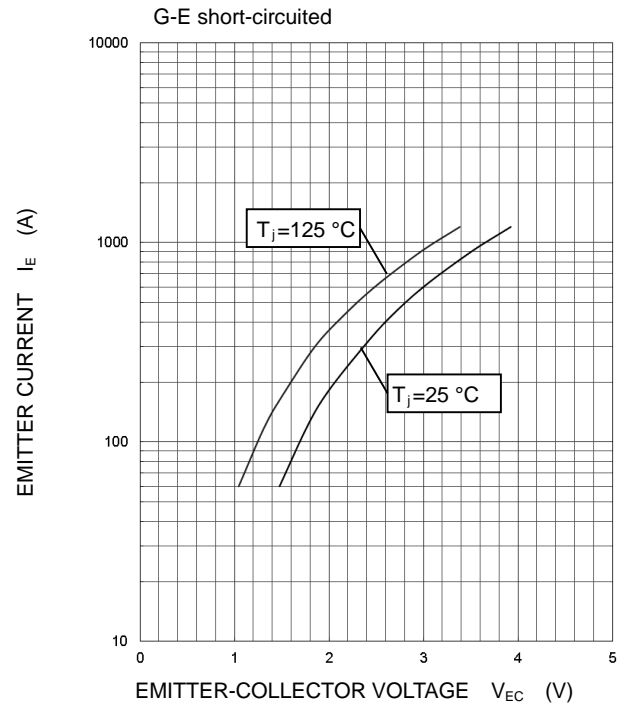
**COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS**

(TYPICAL)



**FREE WHEELING DIODE FORWARD CHARACTERISTICS**

(TYPICAL)



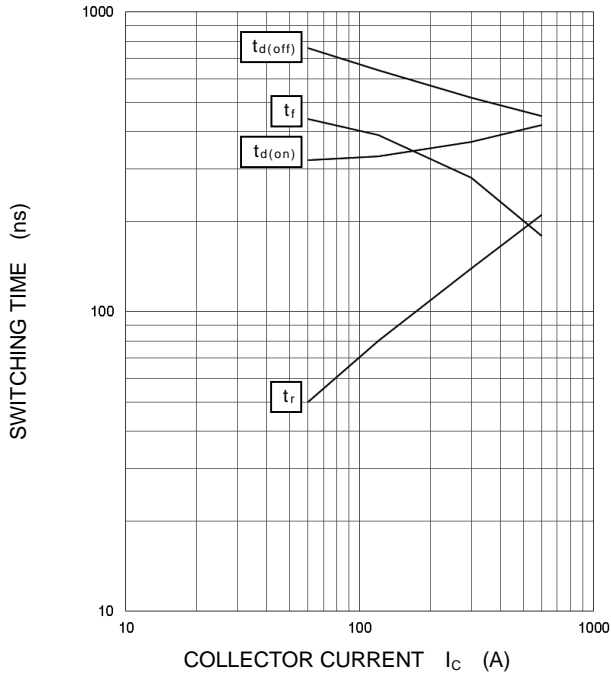
# CM600HA-24A

HIGH POWER SWITCHING USE  
INSULATED TYPE

## PERFORMANCE CURVES

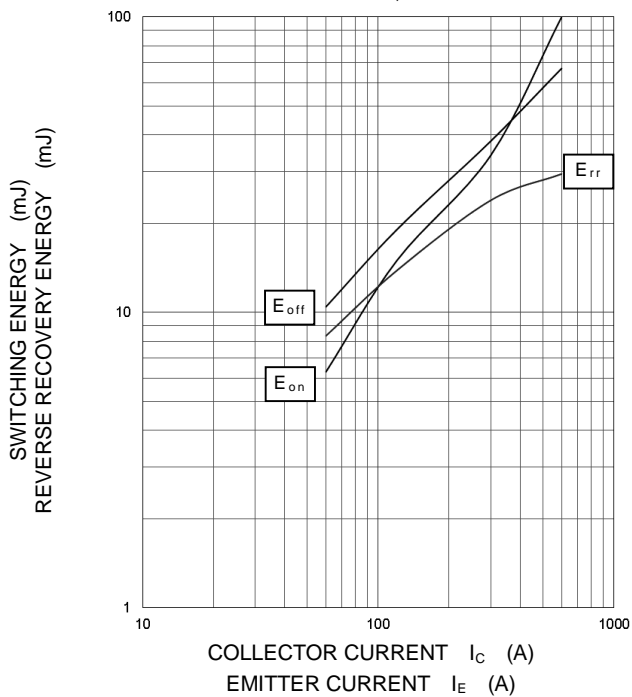
**HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)**

$V_{CC}=600\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $R_G=0.52\ \Omega$ ,  
 $T_j=125\text{ }^\circ\text{C}$ , INDUCTIVE LOAD



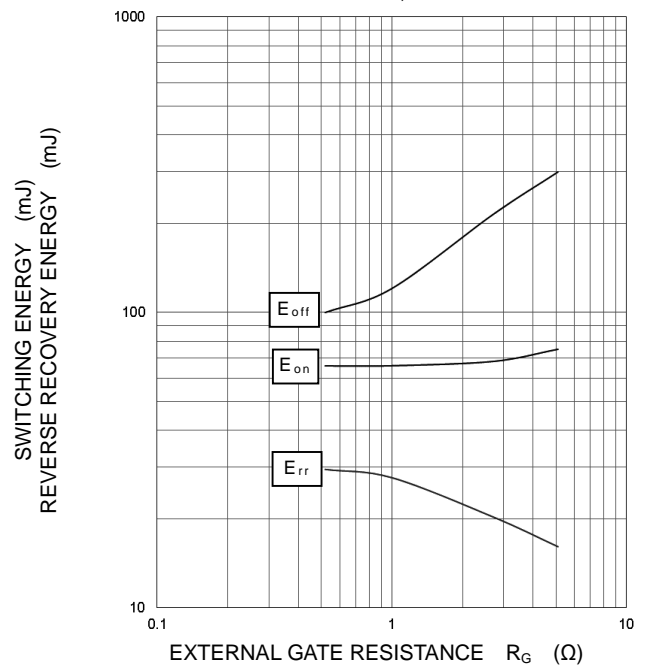
**HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)**

$V_{CC}=600\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $R_G=0.52\ \Omega$ ,  $T_j=125\text{ }^\circ\text{C}$   
INDUCTIVE LOAD, PER PULSE



**HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)**

$V_{CC}=600\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $I_C/I_E=600\text{ A}$ ,  $T_j=125\text{ }^\circ\text{C}$   
INDUCTIVE LOAD, PER PULSE

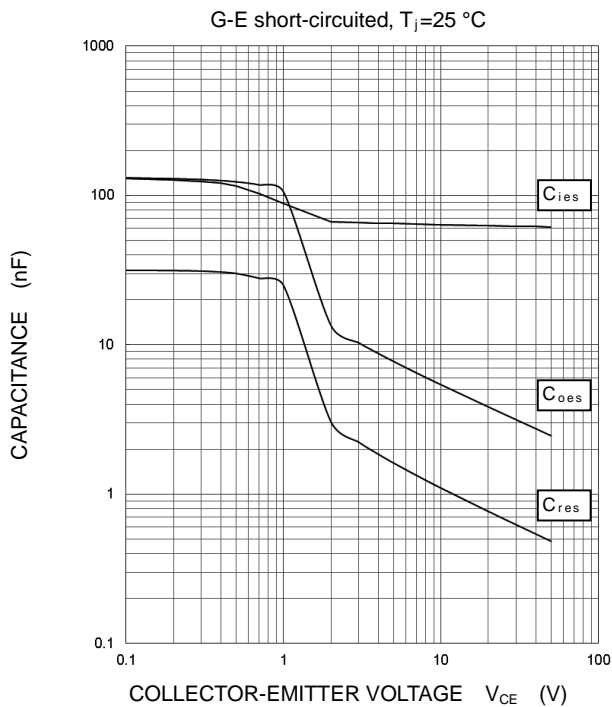


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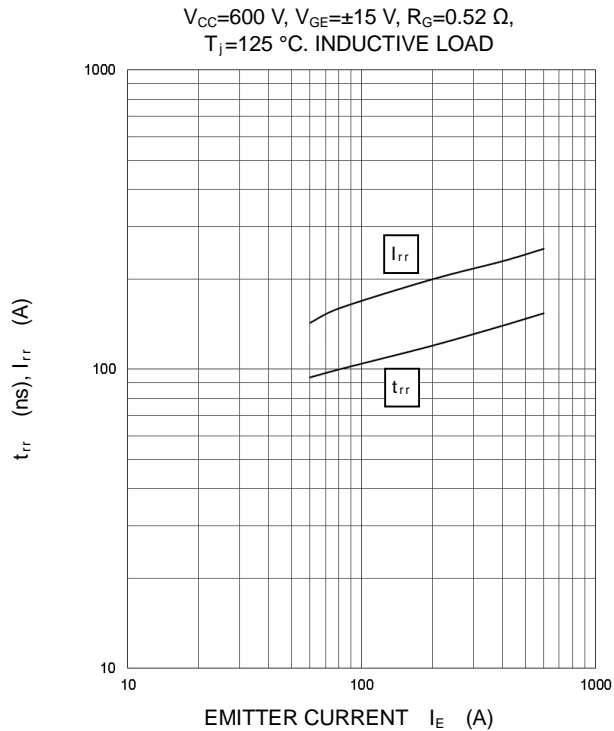
HIGH POWER SWITCHING USE  
INSULATED TYPE

## PERFORMANCE CURVES

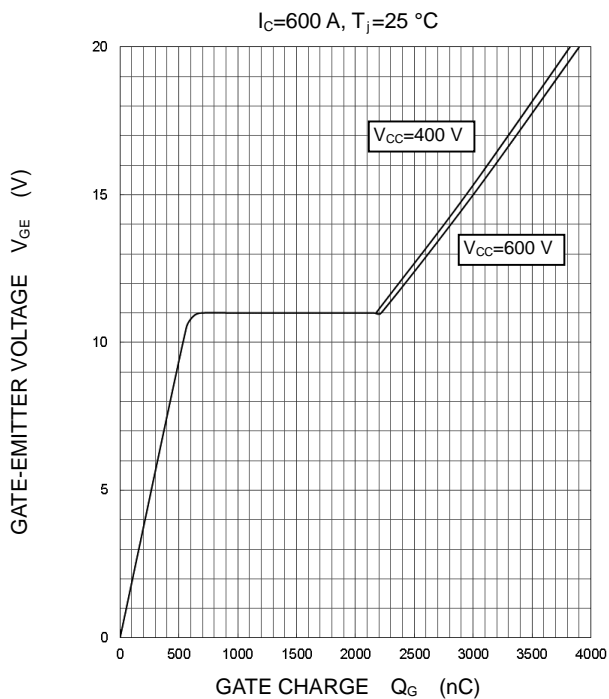
**CAPACITANCE CHARACTERISTICS**  
(TYPICAL)



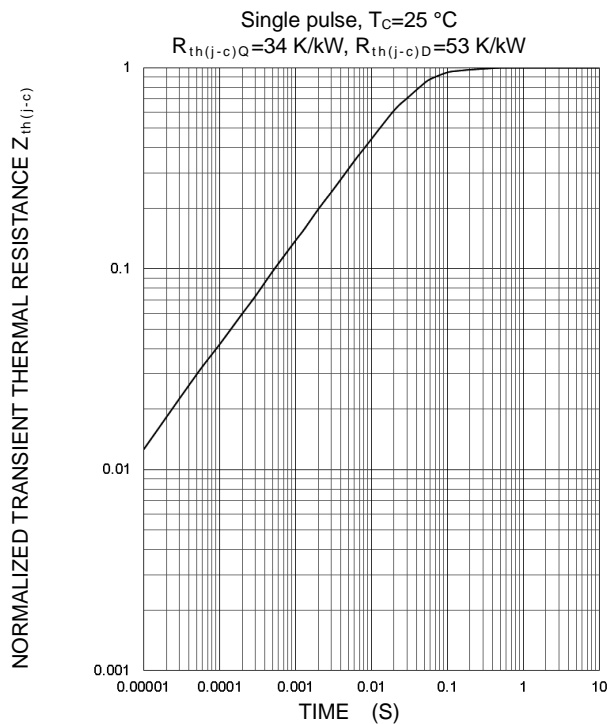
**FREE WHEELING DIODE REVERSE RECOVERY CHARACTERISTICS**  
(TYPICAL)



**GATE CHARGE CHARACTERISTICS**  
(TYPICAL)



**TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS**  
(MAXIMUM)



Note: The characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

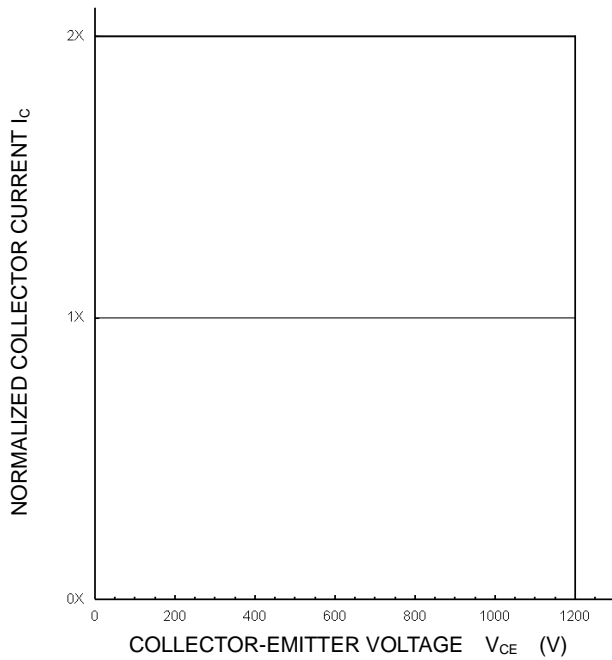
# CM600HA-24A

HIGH POWER SWITCHING USE  
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## PERFORMANCE CURVES

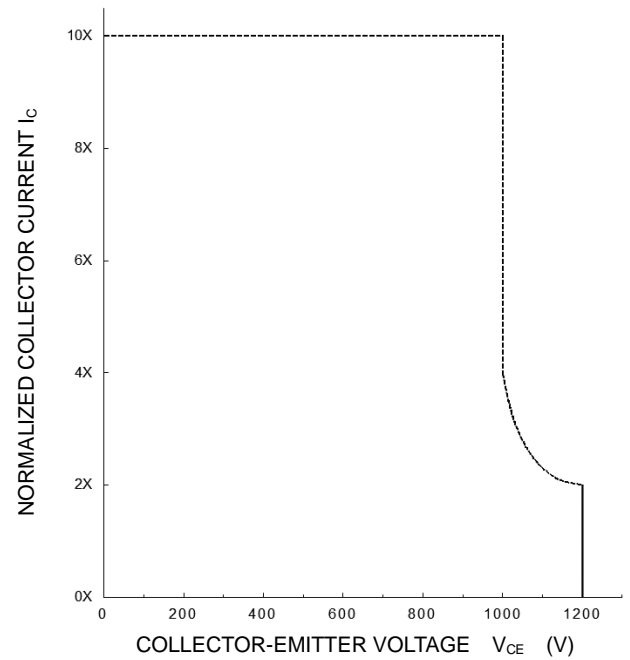
**TURN-OFF SWITCHING SAFE OPERATING AREA  
(REVERSE BIAS SAFE OPERATING AREA)  
(MAXIMUM)**

$V_{CC} \leq 800 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $R_G = 0.52 \sim 7.8 \ \Omega$ ,  $T_j = 25 \sim 125 \text{ }^\circ\text{C}$



**SHORT-CIRCUIT SAFE OPERATING AREA  
(MAXIMUM)**

$V_{CC} \leq 800 \text{ V}$ ,  $V_{GE} = \pm 15 \text{ V}$ ,  $R_G = 0.52 \sim 7.8 \ \Omega$ ,  
 $T_j = 25 \sim 125 \text{ }^\circ\text{C}$ ,  $t_w \leq 10 \ \mu\text{s}$ , Non-Repetitive





## **Keep safety first in your circuit designs!**

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